



MEC1-120-02-F-D-EM2

MEC1-120-02-L-D-RA1-SL

(1,00mm) .03937"

MEC1-RA, MEC1-EM SERIES

# RIGHT ANGLE/EDGE MOUNT SOCKETS

Mates with:  
(1,60mm) .062" card

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see [www.samtec.com?MEC1-RA](http://www.samtec.com?MEC1-RA)

**Insulator Material:** Black LCP  
**Contact Material:** Phosphor Bronze  
**Plating:** Au or Sn over 50µ" (1,27µm) Ni  
**Current Rating:** 1.5A @ 80°C (See website for details)  
**Operating Temp Range:** -55°C to +125°C  
**Insertion Depth:** (5,84mm) .230" to (8,13mm) .320"  
**RoHS Compliant:** Yes



**Processing:** Lead-Free Solderable: Yes  
**SMT Lead Coplanarity:** (0,10mm) .004" max (05-40) (0,15mm) .006" max (50-70)

**Note:** Some sizes, styles and options are non-standard, non-returnable.

MEC1 - 1 POSITIONS PER ROW - CARD SLOT - PLATING OPTION - D - RA1 - SL

**05, 08, 20, 30, 40, 50, 60, 70**

**-02** = (1,60mm) .062" thick card

**-F** = Gold flash on contact, Matte Tin on tail

**-L** = 10µ" (0,25µm) Gold on contact, Matte Tin on tail

**APPLICATION SPECIFIC OPTION**

- Elevated body height
- Non-polarized

Call Samtec.

POSITIONS PER ROW	POLARIZED POSITIONS
05	3, 4
08	5, 6
20	15, 16
30	21, 22
40	31, 32
50	41, 42
60	31, 32, 63 & 64
70	53, 54, 115 & 116

**Note:** Other Gold plating options available. Contact Samtec.

1mm MEC1-RA	Rated @ -3dB Insertion Loss
<b>6,81mm Stack Height</b>	
Single-Ended Signaling	4.5 GHz / 9 Gbps
Differential Pair Signaling	5.5 GHz / 11 Gbps
Complete test data available at <a href="http://www.samtec.com?MEC1-RA">www.samtec.com?MEC1-RA</a> or contact <a href="mailto:sig@samtec.com">sig@samtec.com</a>	

## APPLICATION

Samtec recommends that pads on the mating board be Gold plated.

Mates with:  
(1,60mm) .062" card

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see [www.samtec.com?MEC1-EM](http://www.samtec.com?MEC1-EM)

**Insulator Material:** Black LCP  
**Contact Material:** Phosphor Bronze  
**Plating:** Au or Sn over 50µ" (1,27µm) Ni  
**Operating Temp Range:** -55°C to +125°C  
**Insertion Depth:** (5,84mm) .230" to (8,13mm) .320"  
**RoHS Compliant:** Yes  
**Lead-Free Solderable:** Yes



**Note:** Some sizes, styles and options are non-standard, non-returnable.

MEC1 - 1 POSITIONS PER ROW - 02 - PLATING OPTION - D - EM2

**05, 08, 20, 30, 40, 50, 60, 70**

**-F** = Gold flash on contact, Matte Tin on tail

**-L** = 10µ" (0,25µm) Gold on contact, Matte Tin on tail

**APPLICATION SPECIFIC OPTION**

- Edge mount leads for (0,80mm) .031" thick board
- Non-polarized

Call Samtec.

POSITIONS PER ROW	POLARIZED POSITIONS
05	3, 4
08	5, 6
20	15, 16
30	21, 22
40	31, 32
50	41, 42
60	31, 32, 63 & 64
70	53, 54, 115 & 116

**Note:** Other Gold plating options available. Contact Samtec.

Due to technical progress, all designs, specifications and components are subject to change without notice.

[WWW.SAMTEC.COM](http://WWW.SAMTEC.COM)